



# N-channel 950 V, 0.275 Ω, 17.5 A SuperMESH™ 5 Power MOSFET in TO-247 long leads package

Datasheet - preliminary data

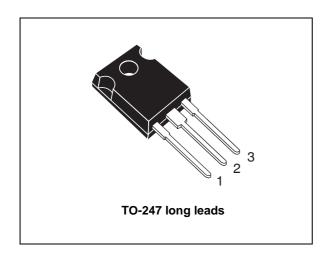
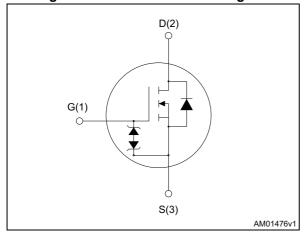


Figure 1. Internal schematic diagram



#### **Features**

Order codes	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>	P <sub>W</sub>
STWA20N95K5	950 V	$0.330~\Omega$	17.5 A	250 W

- Worldwide best FOM (figure of merit)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

#### **Applications**

Switching applications

#### **Description**

This device is an N-channel Power MOSFET developed using SuperMESH™ 5 technology. This revolutionary, avalanche-rugged, high voltage Power MOSFET technology is based on an innovative proprietary vertical structure. The result is a drastic reduction in on-resistance and ultra low gate charge for applications which require superior power density and high efficiency.

Table 1. Device summary

Order codes	Marking	Package	Packaging
STWA20N95K5	20N95K5	TO-247 long leads	Tube

Contents STWA20N95K5

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STWA20N95K5 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate- source voltage	± 30	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	17.5	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	11	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	70	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	250	W
I <sub>AR</sub>	Max current during repetitive or single pulse avalanche (pulse width limited by T <sub>jmax</sub> )	6	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AS}$ , $V_{DD} = 50$ V)	200	mJ
E <sub>SD</sub>	Gate-source human body model (R= 1,5 k $\Omega$ , C = 100 pF)	2	kV
dv/dt (2)	Peak diode recovery voltage slope	6	V/ns
T <sub>j</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 150	°C

<sup>1.</sup> Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case max	0.5	°C/W
Rthj-amb	Thermal resistance junction-amb max	50	°C/W

<sup>2.</sup>  $I_{SD} \leq 17.5 \text{ A, di/dt} \leq 100 \text{ A/}\mu\text{s, V}_{Peak} \leq \text{V}_{(BR)DSS}$ 

Electrical characteristics STWA20N95K5

#### 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	950			٧
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 950 V, V <sub>DS</sub> = 950 V, Tc=125 °C			1 50	μA μA
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	4	5	٧
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9 A		0.275	0.330	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	1500	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> =100 V, f=1 MHz, V <sub>GS</sub> =0	-	80	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	, 23 · · · , · · · , · · d3 · ·	-	5	-	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	$V_{GS} = 0$ , $V_{DS} = 0$ to 760 V	-	170	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	V <sub>GS</sub> = 0, V <sub>DS</sub> = 0 to 700 V	-	65	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1MHz open drain	-	3.5	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 760 V, I <sub>D</sub> = 9 A	-	40	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> =10 V	-	8	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 15)	-	25	-	nC

<sup>1.</sup> Time related is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

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<sup>2.</sup> energy related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 475 \text{ V}, I_{D} = 9 \text{ A},$ $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =10 V	-	17	-	ns
t <sub>r</sub>	Rise time		-	12	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 17)	-	70	-	ns
t <sub>f</sub>	Fall time		-	20	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		17.5	Α
I <sub>SDM</sub>	Source-drain current (pulsed)		-		70	Α
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage I <sub>SD</sub> = 17.5 A, V <sub>GS</sub> =0		-		1.5	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 17.5 A, V <sub>DD</sub> = 60 V	-	530		ns
$Q_{rr}$	Reverse recovery charge	$di/dt = 100 \text{ A}/\mu\text{s},$	-	12		μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 16)	-	44		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 17.5 A,V <sub>DD</sub> = 60 V	-	650		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt=100 A/μs, Tj=150 °C	-	14		μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 16)	-	77		Α

<sup>1.</sup> Pulsed: pulse duration =  $300\mu$ s, duty cycle 1.5%

Table 8. Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)GSO</sub>	Gate-source breakdown voltage	$I_{GS}$ = ± 1 mA, $I_D$ = 0	30	ı	-	V

The built-in-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to source. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

Electrical characteristics STWA20N95K5

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

AM11184v1
Tj=150°C
Tc=25°C
Single pulse
10μs
100μs
1ms
10ms

Figure 3. Thermal impedance

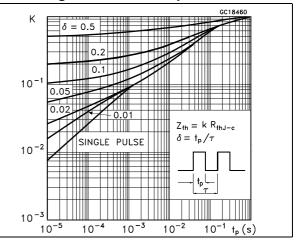


Figure 4. Output characteristics

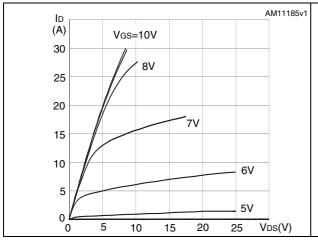
10

100

V<sub>DS</sub>(V)

0.1

Figure 5. Transfer characteristics



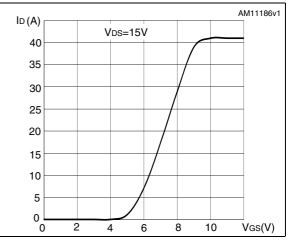
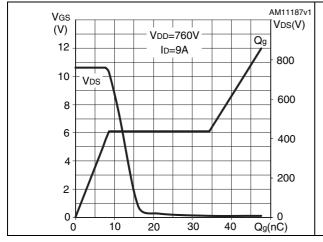
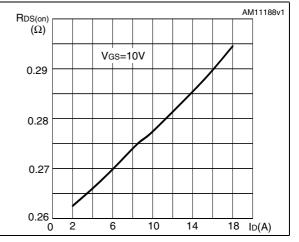


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance



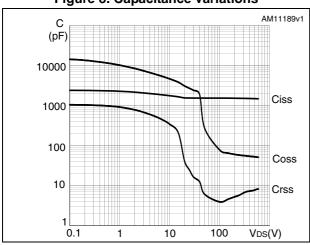


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Figure 8. Capacitance variations

Figure 9. Output capacitance stored energy



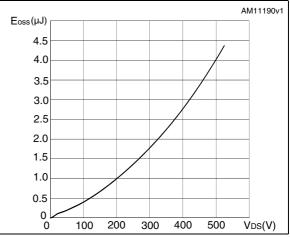
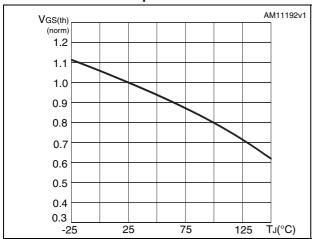


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on-resistance vs temperature



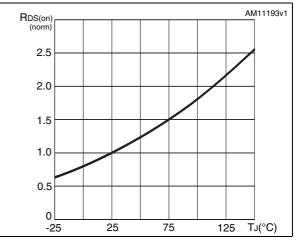
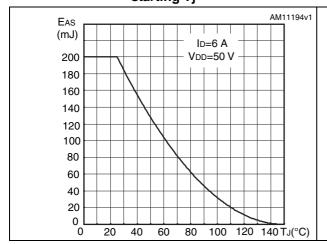
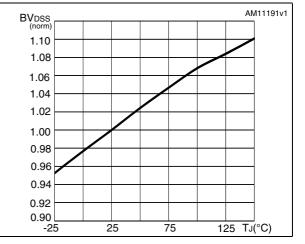


Figure 12. Maximum avalanche energy vs starting Tj

Figure 13. Normalized  $B_{VDSS}$  vs temperature





Test circuits STWA20N95K5

#### 3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

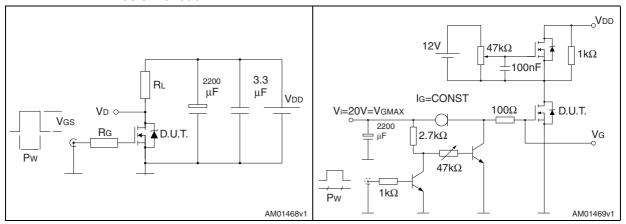


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

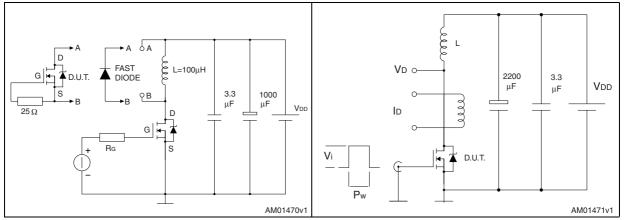
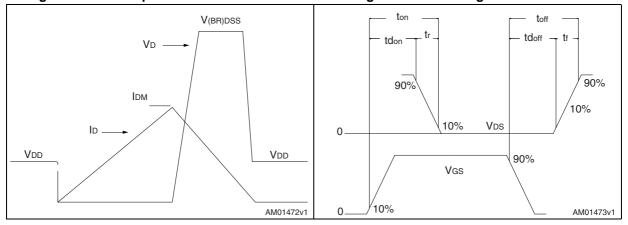


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 9. TO-247 long leads mechanical data

D:		mm			
Dim.	Min.	Тур.	Max.		
А	4.90		5.15		
D	1.85		2.10		
Е	0.55		0.67		
F	1.07		1.32		
F1	1.90		2.38		
F2	2.87		3.38		
G		10.90 BSC			
Н	15.77		16.02		
L	20.82		21.07		
L1	4.16		4.47		
L2	5.49		5.74		
L3	20.05		20.30		
L4	3.68		3.93		
L5	6.04		6.29		
М	2.25		2.55		
V		10°			
V1		3°			
V3		20°			
Dia.	3.55		3.66		



HEAT-SINK PLANE -D -D¦A F2 2 BACK VIEW 7395426\_G

Figure 20. TO-247 long leads drawing

STWA20N95K5 Revision history

# 5 Revision history

Table 10. Document revision history

Date	Revision	Changes
21-Nov-2013	1	First release.

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